					《外找股份》
SPEC NO.	SP03AE2450B-0010	ISSUED DATE	2012.06.15	PU	品保部等
DDODLICT NAME	DCA 170000 14	VERSION	04		2012.06.18
PRODUCT NAME	PCAK0000-14	PAGE	1/13		文件管制動

SPECIFICATION

SPEC NO. : SP03AE2450B-0010

PART NO. : 03C40D4X0000110

PRODUCT NAME : PCAK0000-14

Print Chip Antenna(5.0x2.0x1.0mm)

DESCRIPTION:

ROHS Compliant Product

REVISION STATUS

VERSION	DATE	PAGE	REVISION DESCRIPTION	PREPARED	CHECKED	APPROVED
01	2010.09.09		新制訂	徐嫚君	黄信嘉	徐偉泓
02	2010.10.20	13	修改 Delivery mode 圖面	徐嫚君	黃信嘉	黃信嘉
03	2011.02.09	6 · 9	修改 Efficiency	徐嫚君	黃信嘉	徐偉泓
04	2012.06.15	13	修改 Delivery mode 圖面	徐嫚君	曾建華	黃信嘉

Prepared By	Checked By	Approved By
徐媛君	曾建華	黄信嘉

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	PRODUCT NAME	DC 4 170000 14	VERSION	04	
		PCAK0000-14	PAGE	2/13	



CIROCOMM TECHNOLOGY.

PART NUMBER: 03C40D4X0000110

1. SCOPE

This specification covers the print chip antenna for WIFI and Bluetooth .

2. Name of the product

This product is named "Print Chip Antenna".

3. Electrical characteristics

3-1 Electrical characteristics of antenna

The antenna has the electrical characteristics given in Table 1 under the *cirocomm* standard installation conditions shown in the figure of Evaluation Board.

Table 1

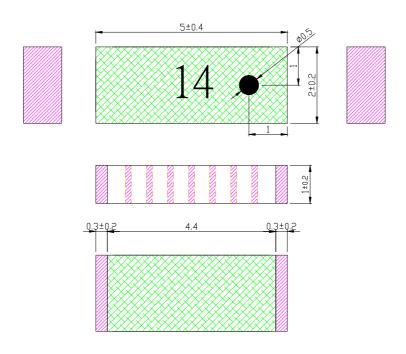
No	Parameter	Specification
1	Working Frequency	2400-2500 MHz
2	Dimension	5.0×2.0×1.0 mm
3	Return Loss	< -10dB
4	VSWR	2 .0max
5	Peak Gain	1.0 dBi (typ)
6	Polarization	Linear
7	Azimuth	Omni-directional
8	Impedance	50 Ω
9	Operating Temperature	-40~105℃

^{*} Actual value will depend on customer ground plane size

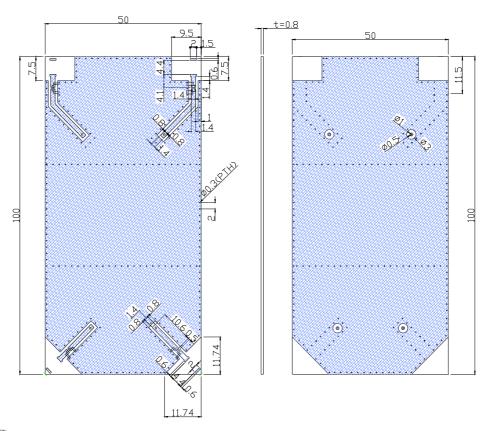
					多品保部 分
SPEC NO.	SP03AE2450B-0010	ISSUED DATE	2012.06.15	PU	2012.06.18
	DCA 120000 14	VERSION	04		
PRODUCT NAME	PCAK0000-14	PAGE	3/13		文件管制拿

4. Antenna & Demo Board Dimension

4-1 Antenna Dimension



4-2 Demo Board Dimension



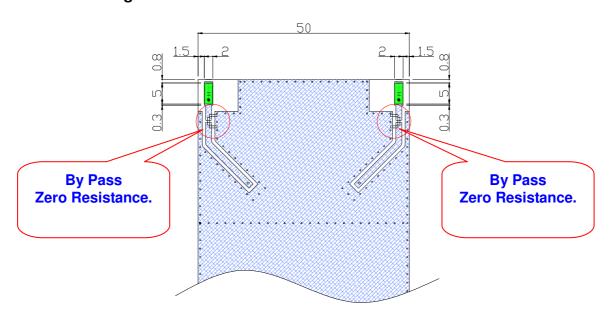
SPEC NO.	SP03AE2450B-0010	ISSUED DATE	2012.06.15	PU
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	PCAK0000-14	PAGE	4/13	



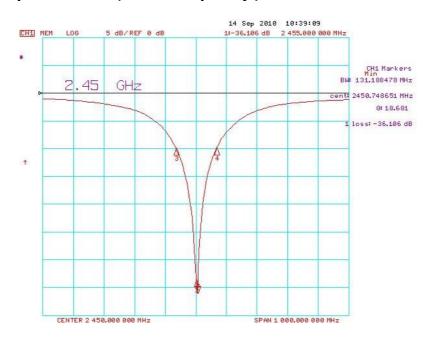
5. Antenna Measurement on Demo Board

5-1 Layout 1 Measurement

5-1-1Matching Circuit



5-1-2 S11 Response curve (Work Frequency)

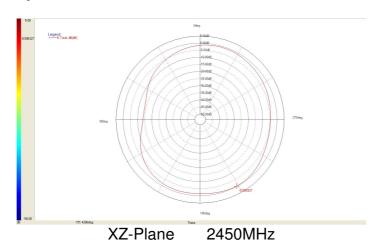


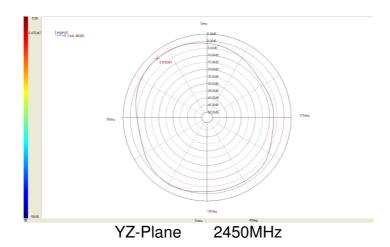
Item	Frequency	Return Loss	Bandwidth
Value	2450 MHz	-25.40dB	124.9 MHz

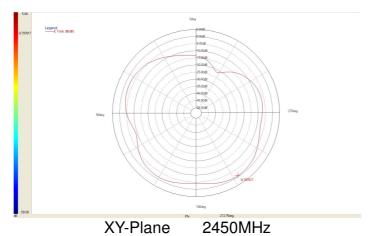
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5-1-3 Electrical performance







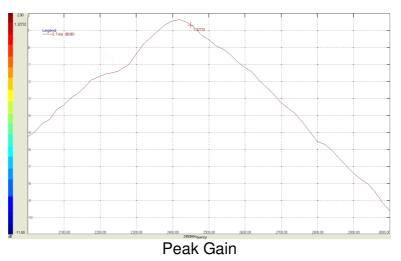
2450MHz	Peak Gain
XZ-Plane	-0.50
YZ-Plane	0.47
XY-Plane	-0.79

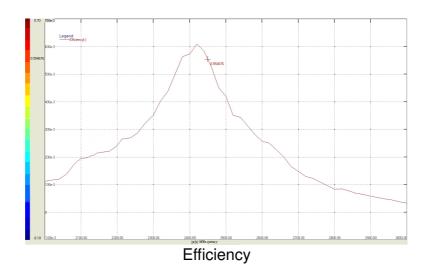
(Unit: dBi)



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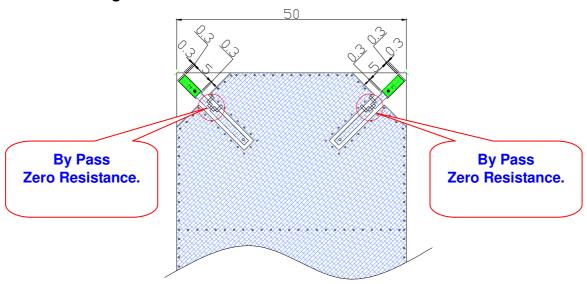
Item	Peak Gain	Efficiency	Average
Value	1.32 dBi	55%	-2.56 dBi

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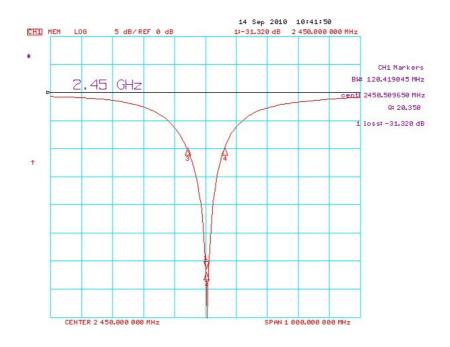


5-2 Layout 2 Measurement

5-2-1Matching Circuit



5-2-2 S11 Response curve (Work Frequency)

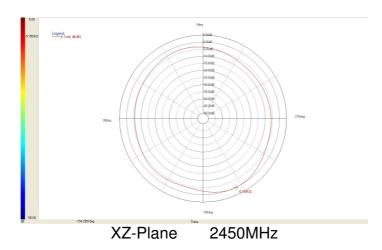


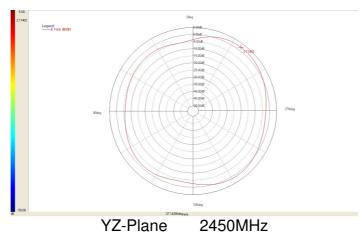
Item	Frequency	Return Loss	Bandwidth
Value	2450 MHz	-25.74dB	125.63 MHz

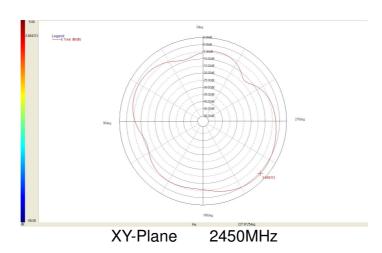
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5-2-3 Electrical performance







2450MHz	Peak Gain
XZ-Plane	-0.15
YZ-Plane	2.11
XY-Plane	0.68

(Unit: dBi)

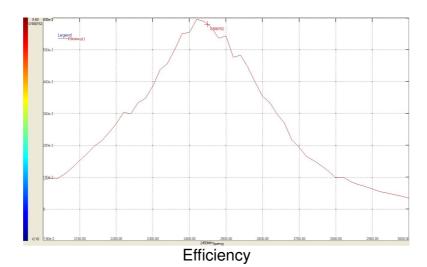


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Peak Gain



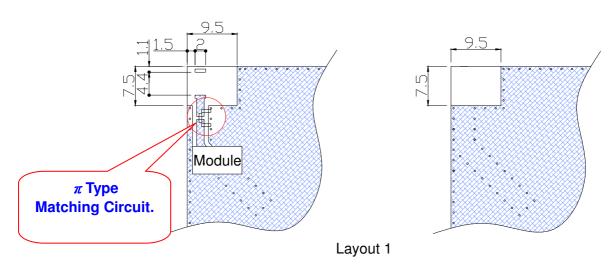
Average Gain

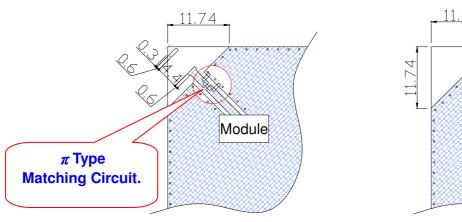
Item	Peak Gain	Efficiency	Average
Value	2.66 dBi	58.01%	-2.36 dBi

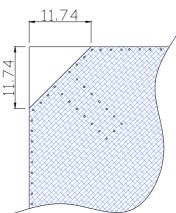
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6. Customer's Requirement Layout Dimension







Layout 2

7. Environmental conditions

7-1 Operating conditions

The antenna has the electrical characteristics given in Tables 1 in the temperature range of -20 $^{\circ}$ C to +80 $^{\circ}$ C and under the environmental conditions of +40 $^{\circ}$ C and 20~80% relative humidity.

7-2 Storage temperature range

The storage temperature range of product is 0° C to $+40^{\circ}$ C.



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8. Reliability tests

8-1 Low-temperature test

Expose the specimen to -20°C for 168 hours and then to normal temperature/humidity for 24 hours or more. After this test, examine its appearance and functions.

8-2 High-temperature test

Expose the specimen to +80°C for 168 hours and then to normal temperature/humidity for 24 hours or more. After this test, examine its appearance and functions.

8-3 High-temperature/high-humidity test

Subject the object to the environmental conditions of $+80^{\circ}$ C and 90-95% relative humidity for 96 hours, then expose it to normal temperature/humidity for 24 hours or more. After this test, examine its appearance and functions.

8-4 Thermal shock test

Subject the object to cyclic temperature change (-20°C, 30 minutes ⇔+80°C, 30 minutes) for 5 cycles, then expose it to normal temperature/humidity for 24 hours or more.

8-5 Vibration test

8-8-1 Sinusoidal vibration test

Subject the object to vibrations of 5 to 200 to 5Hz swept in 10 minutes, 4.5G at maximum (2mm amplitude), in X and Y directions for two hours each and in Z direction for four hours. After this test, examine its appearance functions.

8-8-2 Vibration test in packaged condition

Subject the object, which is packaged as illustrated, to vibrations of 15 to 60 to 15Hz swept in 6 minutes, 4G at maximum (2mm amplitude at maximum), applied in X, Y and Z directions for two hours each, i.e. six hours in total. After this test, examine its appearance and functions.

8-6 Free fall test in packaged condition

Drop the object, which is packaged as illustrated, to a concrete surface from the height of 90 cm, on one comer, three edges and six faces once each, i.e. 10 times in total. After this test, examine its appearance and functions.

8-7. Soldering heat resistance test

After the lead pins of the unit are soaked in solder bath at 270 \pm 5°C for 10 \pm 0.5 seconds and then be left for more than 1 hour at 25 \pm 5°C in less than 65% relative humidity.



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8-8. Adhesion test

The device is subjected to be soldered on test PCB. Then apply 0.5Kg(5N) of force for 10±1 seconds in the direction of parallel to the substrate. (the soldering should be done by reflow and be conducted with care so that the soldering is uniform and free of defect by stress such as heat shock).

9. Warranty

If any defect occurs form the product during proper use within a year after delivery, it will be repaired or replaced free of charge.

10. Other

Any question arising from this specification manual shall be solved by arrangement made by both parties.

11. Precautions for use

Antenna pattern use a Sn electrode.

Please don't use the corrosion gas (sulfur gas, chlorine gas) in the atmosphere.

Please don't direct solder onto the Sn electrode of Antenna pattern.

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Delivery mode

1 Blister tape to IEC 286-3, polyester •

2 Pieces/tape: 1500

